

Kyocera SLD Laser

LaserLight SMD 1000 60C 10KHR

Technical Documentation

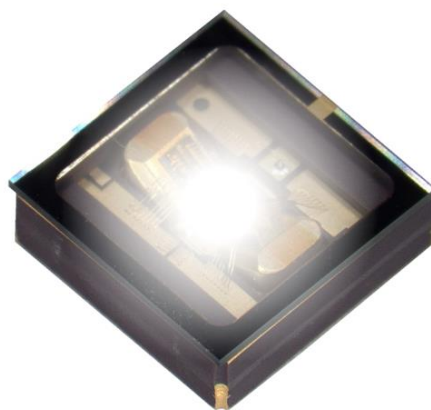


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General Introduction – LaserLight SMD

LaserLight SMD by SLD Laser is the world's first high luminance, white laser light emitter in a compact 7mm SMD. Featuring 1000 lumens and up to 1300 Mcd/m², LaserLight SMD enables ultra-long throw distances, narrow beam angles and small optic sizes for specialty lighting applications.

FEATURES & BENEFITS

- Worlds highest luminance 1300 Mcd/m²
- Enables less than 3 degree beam angle from 35mm optic
- Stable efficacy vs. drive power
- Compact 7mm SMD with built-in safety features

LIGHTING APPLICATIONS

- Portable and Search & Rescue
- Automotive
- Architectural
- Outdoor
- Entertainment

Ordering Part Numbers

Part Number	Part Description
910-00049-A0V0-WF	LaserLight SMD, 1000 lumen, PWM, 6000K, 60C, 10KHR in Waffle Pack Packaging
910-00049-A0V0-TR	LaserLight SMD, 1000 lumen, PWM, 6000K, 60C, 10KHR in Tape & Reel
910-00049-A0V0-IT	LaserLight SMD, 1000 lumen, PWM, 6000K, 60C, 10KHR on Star MCPCB

Part Numbers Nomenclature

910	-	XXXXX	-	A	#	V#	-	YY
Product Family		Product Designation		Color Bin	Luminous Flux Bin	Voltage Bin		Packaging
910 : LaserLight SMD		00049 : Internal Code		A : Full Bin (Table 1)	0 : 900 - 1300lm	V0 : 7.8 - 9.0 V		<u>SMD Packaging</u> WF : Waffle Pack TR : Tape & Reel <u>Starboard Packaging</u> IT : Industrial Tray

Photometric Characteristics*

Attribute	unit	Minimum value	Typical value	Maximum Value
Luminous Flux	lm	900	1000	1300
Luminous Intensity	cd		318	
Peak Luminance	cd/mm ²		1300	
Spot size x (FWHM)	mm		0.45	
Spot size y (FWHM)	mm		0.55	
Viewing Angle	degrees		120	
Position Tolerance of Emission Spot Center (Peak Luminance Maximum) in X direction	mm	-0.200		0.200
Position Tolerance of Emission Spot Center (Peak Luminance Maximum) in Y direction	mm	-0.200		0.200
Position Tolerance of Emission Spot Center (Peak Luminance Maximum) in Z direction	mm	-0.100		0.100
Correlated Color Temperature**	K	5310	6000	7040
Color Rendering Index (CRI)			70	

* Photometric characteristics are described at $I_f = 2.5A$ and $T_{case} = 60^{\circ}C$ unless otherwise specified. With photometric tolerances of $\pm 7\%$.

** See Color Bin Structure for additional information

Operating Limits, Electrical Characteristics, and Thermal Characteristics*

Parameter	unit	Minimum value	Typical value	Maximum Value
Forward Current (I_f), DC	A	0.70**	2.5	2.5
Forward Current (I_f), Pulsed peak current***	A			2.5
Maximum reverse current	A			0
Operating Voltage	V	7.8	8.2	9.0
Thermal (heat) dissipated power	W		18	
Maximum operating temperature				****
ESD Resistance (HBM Level 1)			2kV	
Pulse Rise and Fall Time	ns		0.5	

* Operating limits, electrical characteristics, and thermal characteristics are described at $I_f = 2.5A$ and $T_{case} = 60^\circ C$ unless otherwise specified.

**Below the laser threshold current (about $I_f = 700mA$ at $T_{case}=60^\circ C$) the luminous flux will go towards zero.

***Forward currents above 2.5A may result in early failures.

****See derating curve (Figure 05)

Table 1: Color binning structure*
($I_f = 2.5A$, $T_{case} = 60^\circ C$)

Nominal CCT, K	x	y	Bin Code
6500	0.3381	0.3762	A
	0.3005	0.3415	
	0.3068	0.3113	
	0.3366	0.3369	

*Kyocera SLD Laser maintains tolerance of ± 0.005 in C_{cx} and C_{cy} .

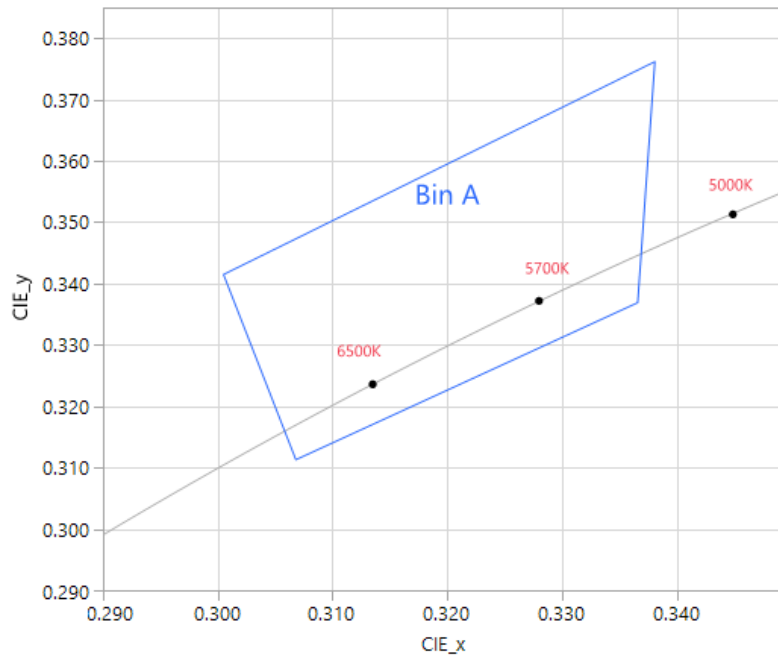


Figure 01: Chromaticity bin plotted

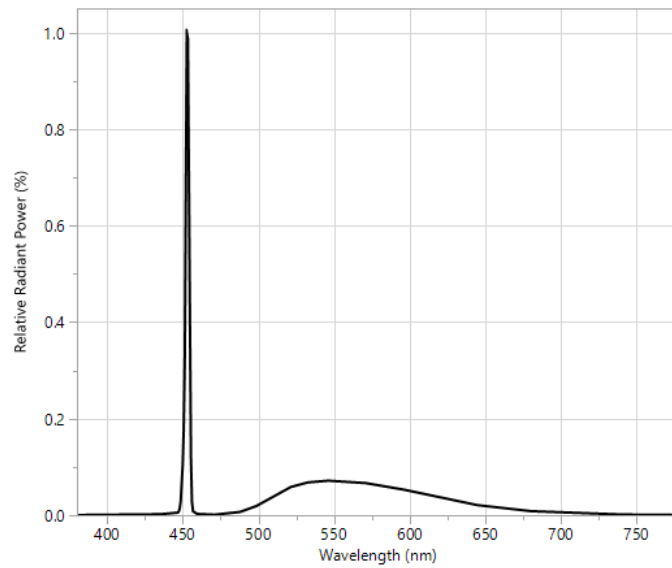


Figure 02: Typical spectral power distribution of 6500K component
($I_f = 2.5A$, $T_{case} = 60^{\circ}C$)

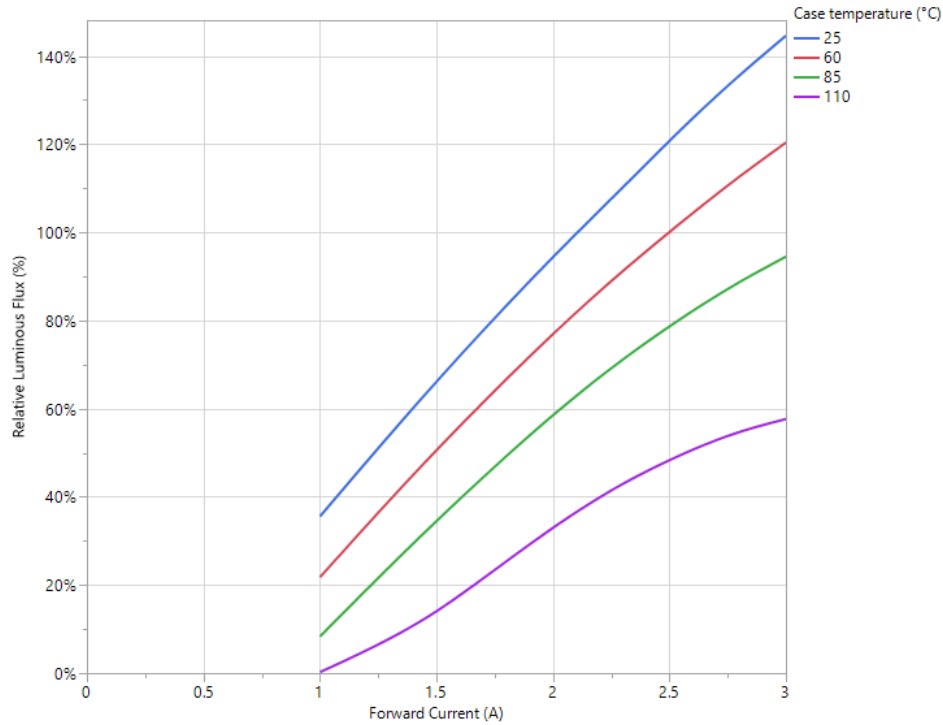


Figure 03: Relative flux vs forward current
(Normalized to at $I_f = 2.5\text{A}$ and $T_{\text{case}} = 60^\circ\text{C}$)

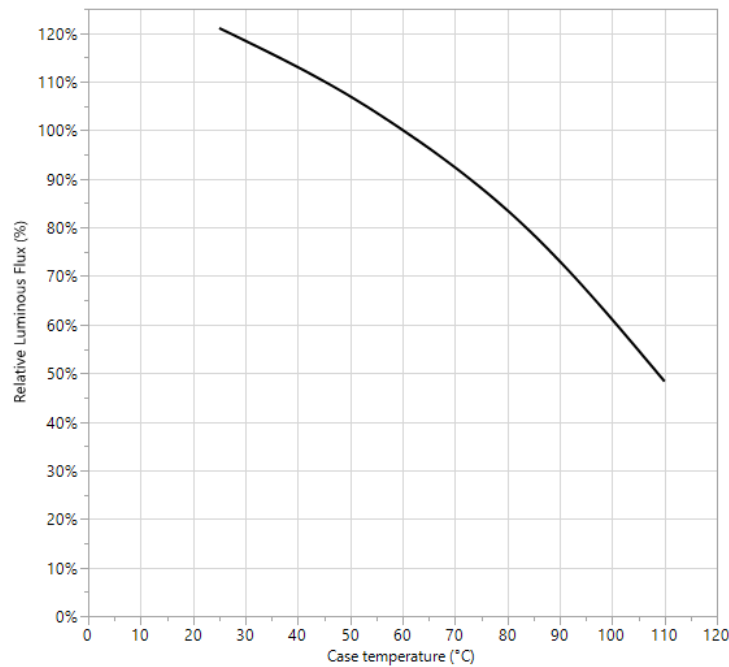


Figure 04: Relative luminous flux vs case temperature
(Normalized luminous flux at $I_f = 2.5\text{A}$ and at $T_{\text{case}} = 60^\circ\text{C}$)

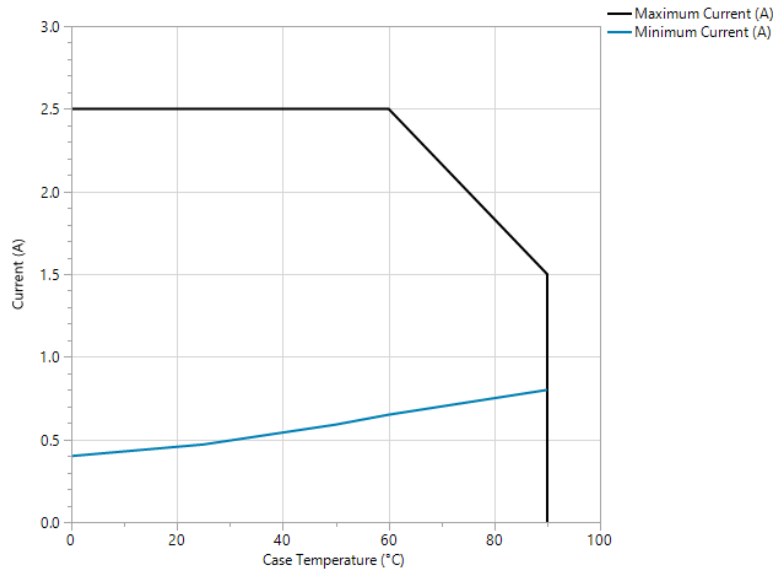


Figure 05: Maximum and minimum current vs temperature to maintain performance and lifetime of component. Operating below minimum current will result in near zero light output.

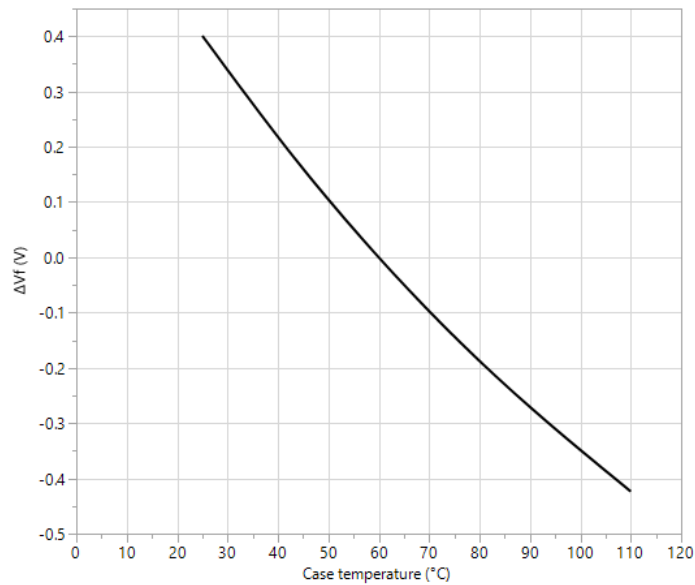


Figure 06: Forward voltage vs temperature
(Measured at $I_f = 2.5A$ and normalized at $T_{case} = 60^\circ C$)

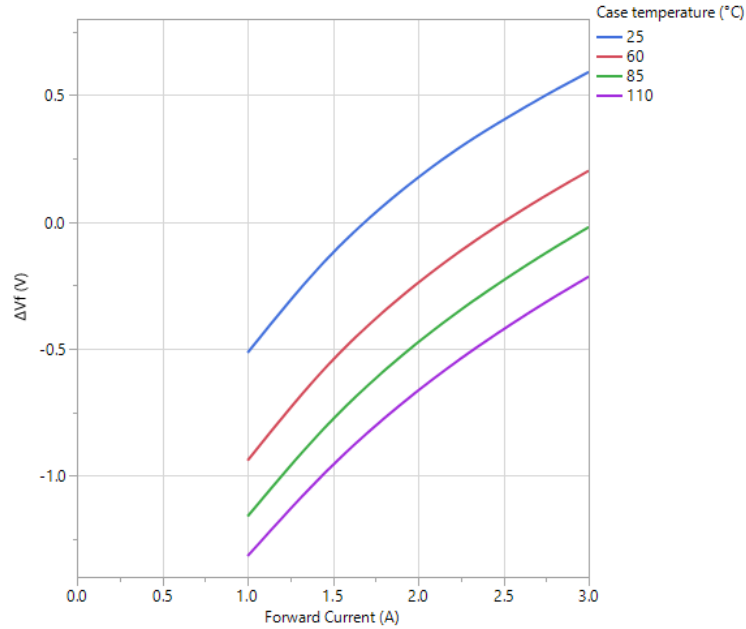
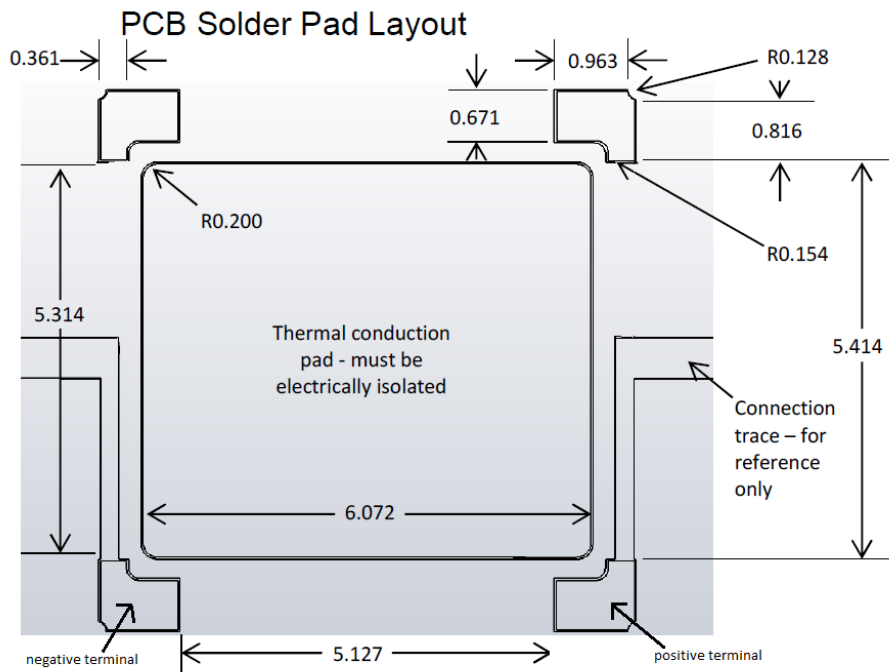
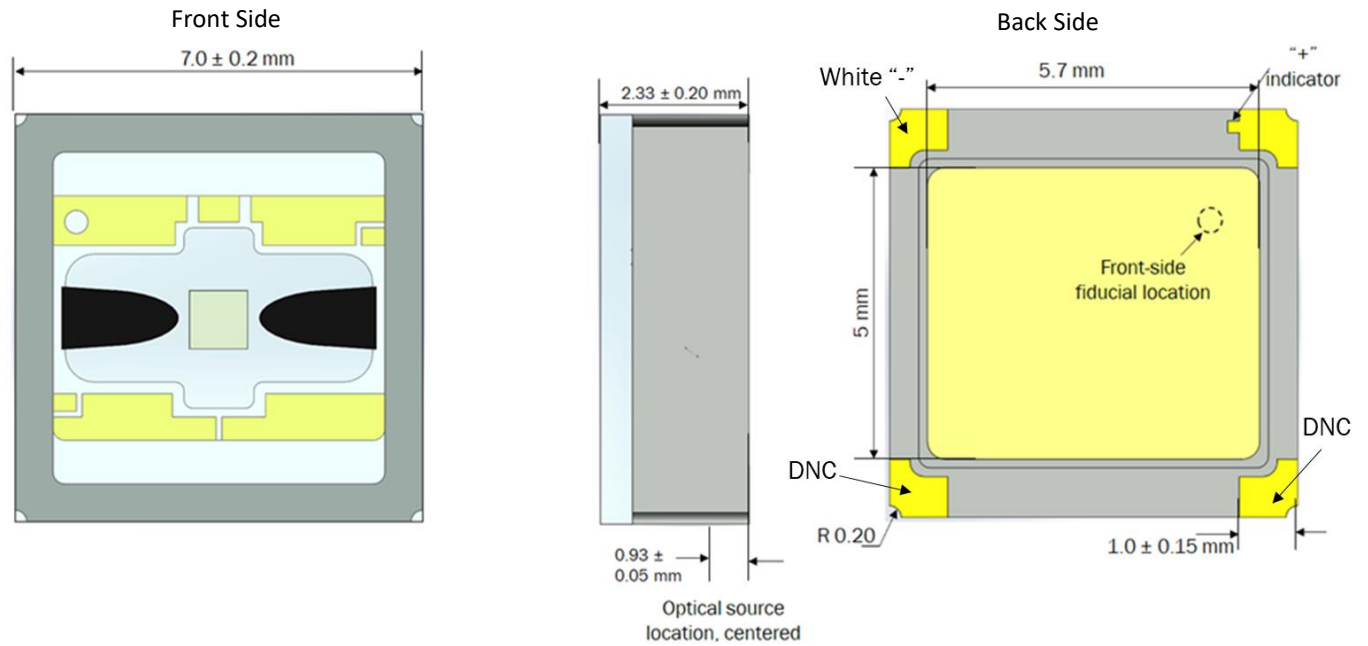


Figure 07: Change in forward voltage vs forward current
(Normalized to at $I_f = 2.5\text{A}$ and $T_{\text{case}} = 60^\circ\text{C}$)

LaserLight SMD Part Mechanical Layouts



Dimensions mark
copper pad layouts

Recommended solder
resist stencil patterns
with 0.075mm inside
clearance on all sides

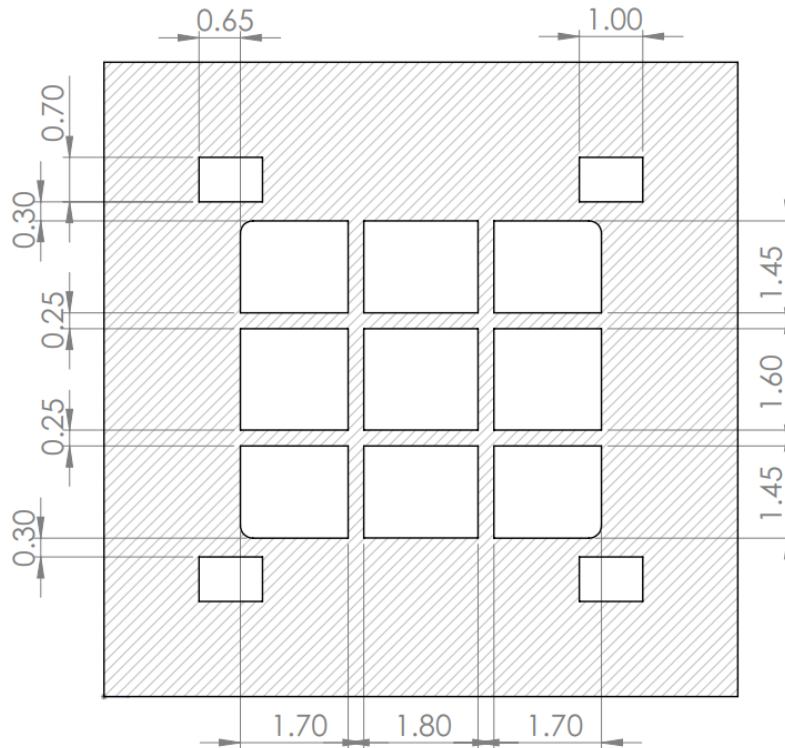
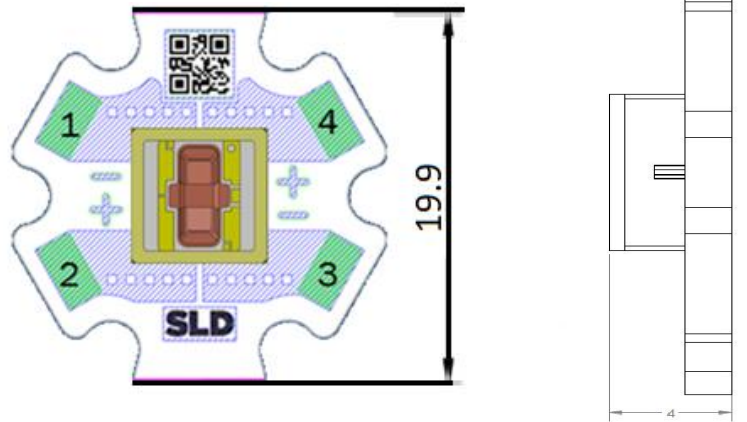


Figure 8: Recommended stencil mask design

Option for Star MCPCB Mounting



Contact position number	Number
1	Do not connect
2	Do not connect
3	Cathode (Laser -)
4	Anode (Laser +)

Circuit Diagram

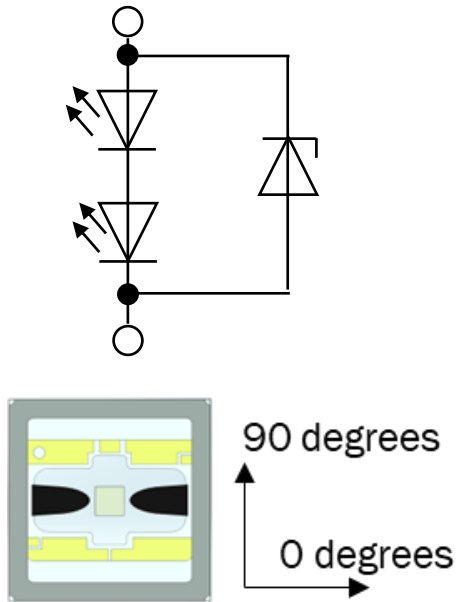


Figure 9: Orientation for near and far field plots

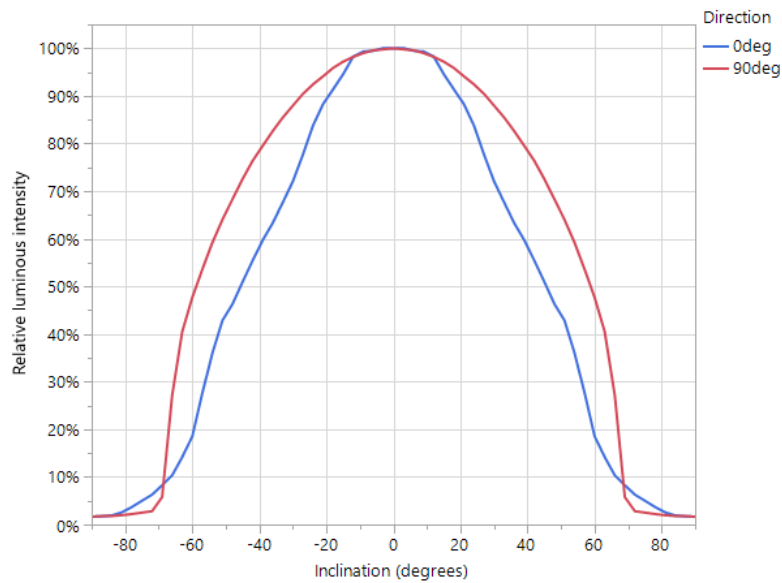


Figure 10: Far field distribution
(Measured at $I_f = 2.5A$ and at $T_{case} = 50^{\circ}C$, normalized to 0,0 position)

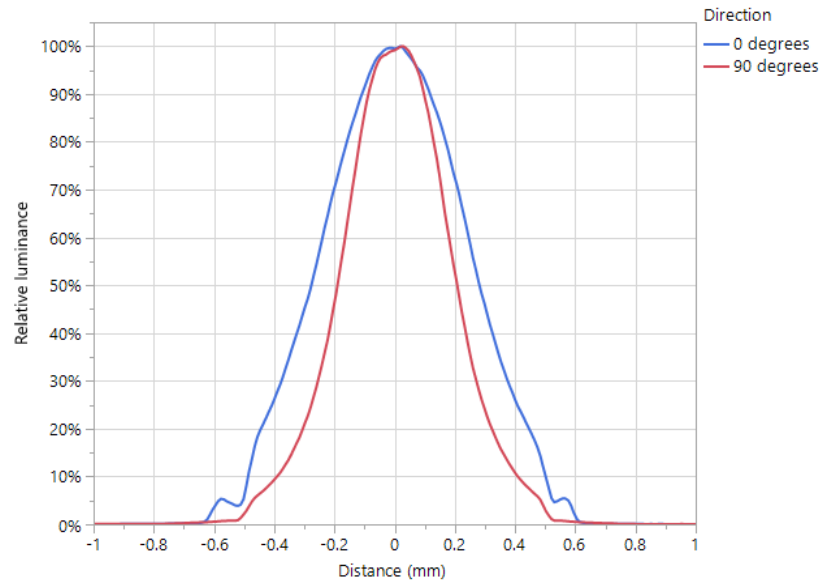


Figure 11: Near field relative luminance
(Measured at $I_f = 2.5A$ and at $T_{case} = 50^{\circ}C$, normalized to 0,0 position)

Ambient Conditions

a. Temperature

Attribute	unit	min	nom	max
Storage temperature (passive)	$^{\circ}C$	-40		135

Life Time

Attribute	unit	nom
L70 continuous operation MTTF (mean time to failure)	hr	10,000

The above mentioned life time specification is fulfilled if the case temperature is maintained at $60^{\circ}C$ at the case or lower or part is de-rated.

Case temperature description

The case temperature (T_{case}) is measured on the metal core printed circuit board (MCPCB) near the thermal solder pad of the component. To ensure accuracy of the case temperature reflecting stated performance good thermal contact between two interfaces: 1) the component and MCPCB and 2) the thermocouple or thermal measurement device and the MCPCB. See Figure 12 for recommended location of T_{case} .

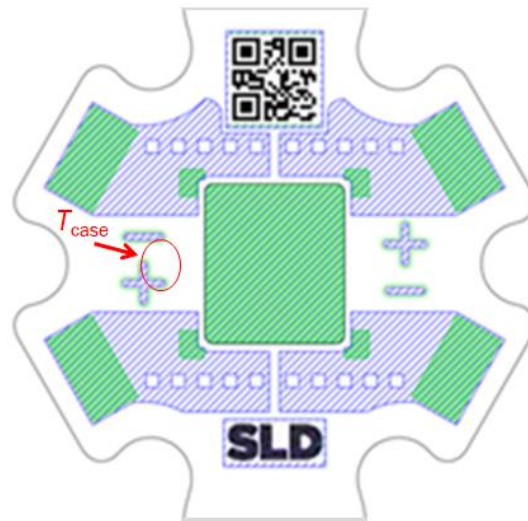
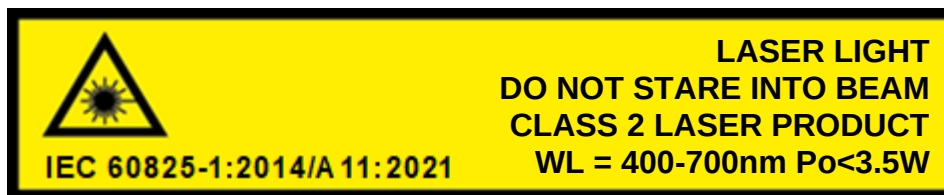


Figure 12: Recommended location of T_{case} measurement

Laser Safety Rating Information

LaserLight SMD has independent UL certification for the solid-state lighting safety standard ANSI/UL 8750 for Light Emitting Diode (LED) Equipment for Use in Lighting.

The LaserLight SMD component is a “Class 2 Laser Product” under IEC 60825-1:2014 standard. Maximum output of laser light is 3.5mW and emitted wavelengths are 450-700nm. SMD is rated “Risk Group 2” for IEC 62471:2006 Photobiological safety of lamps and lamp systems, moderate risk. This means the system is safe for typical use as long as reasonable precautions are taken to avoid direct constant eye exposure to the illuminated portion of the device. The direct laser is sealed in its case and not visible. Only the diffuse converted white light from the phosphor is visible. Caution – Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.



Informations sur la sécurité laser

LaserLight SMD dispose d'une certification UL indépendante pour la norme de sécurité d'éclairage à semi-conducteurs ANSI / UL 8750 pour les équipements à diodes électroluminescentes (LED) à utiliser dans l'éclairage.

Le produit LaserLight SMD est un «produit laser de classe 2» selon la norme CEI 60825-1: 2014. La puissance maximale de la lumière laser est de 3,5 mW et les longueurs d'onde émises sont de 450 à 700 nm. SMD est classé «Groupe de risque 2» pour la CEI 62471: 2006 Sécurité photobiologique des lampes et des systèmes de lampes, risque modéré. Cela signifie que le système est sûr pour une utilisation typique tant que des précautions raisonnables sont prises pour éviter une exposition oculaire directe et constante à la partie éclairée de l'appareil. Le laser direct est scellé dans son boîtier et non visible. Seule la lumière blanche diffuse convertie du luminophore est visible. Attention - L'utilisation de commandes ou de réglages ou l'exécution de procédures autres que celles spécifiées dans ce document peuvent entraîner une exposition à des radiations dangereuses.



Handling Instructions

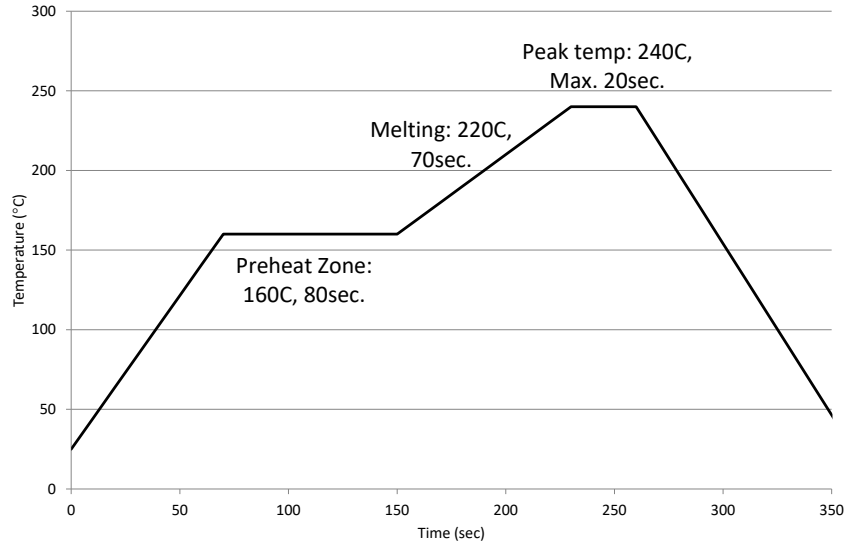
- Handle the component by its package only
- Never hold the component by the glass window
- This product is sensitive to electrostatic discharge (ESD) and should be handled at a static free workstation.

Take the following precautions to protect the component against ESD or electrical overdrive which can cause unexpected component failure:

- Power supply must be off when connected. Do not connect to live power
- Power supply must be current limited with voltage maximum
- The user must be connected to the ground and use anti-static gloves.
- Use wrist straps in direct contact with skin.
- Use grounded work surfaces and semi-conductive anti-static table material.
- The user's feet must touch the floor.

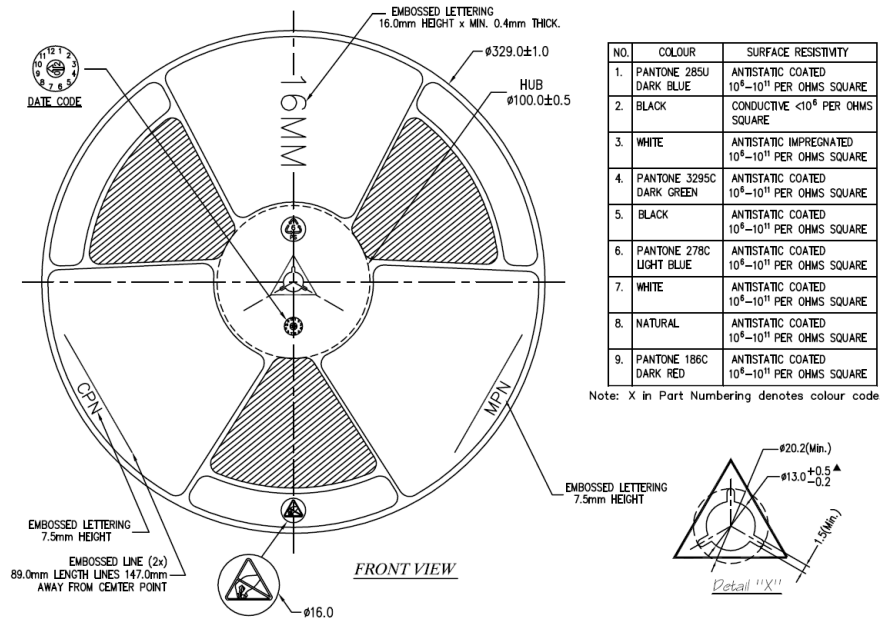
Soldering Conditions

Lead free Solder



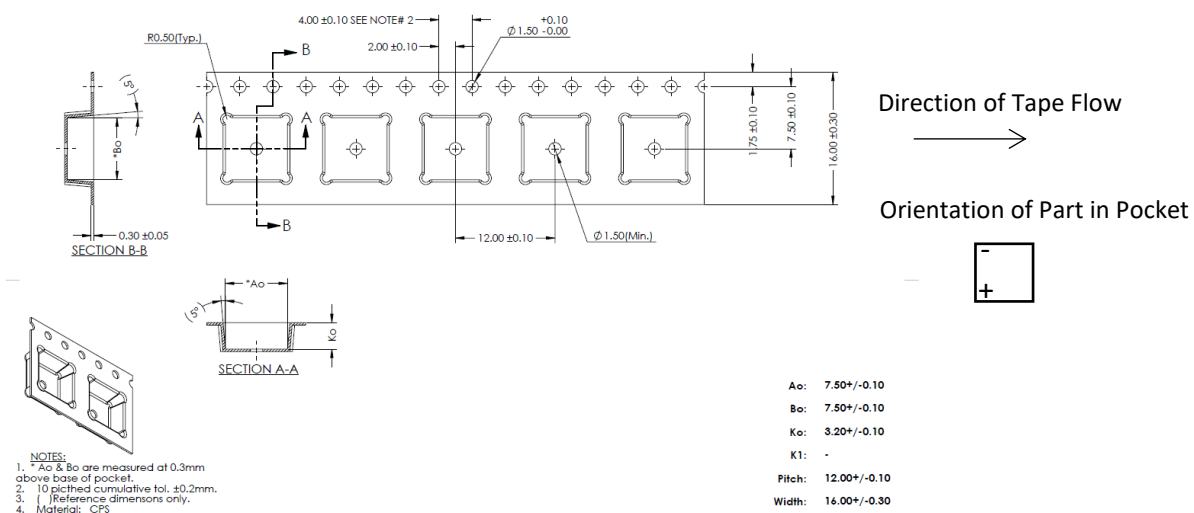
Shipment Packaging and Container Information

Tape and Reel Diagram



Standard packaging increment (SPI) is 500 parts per reel

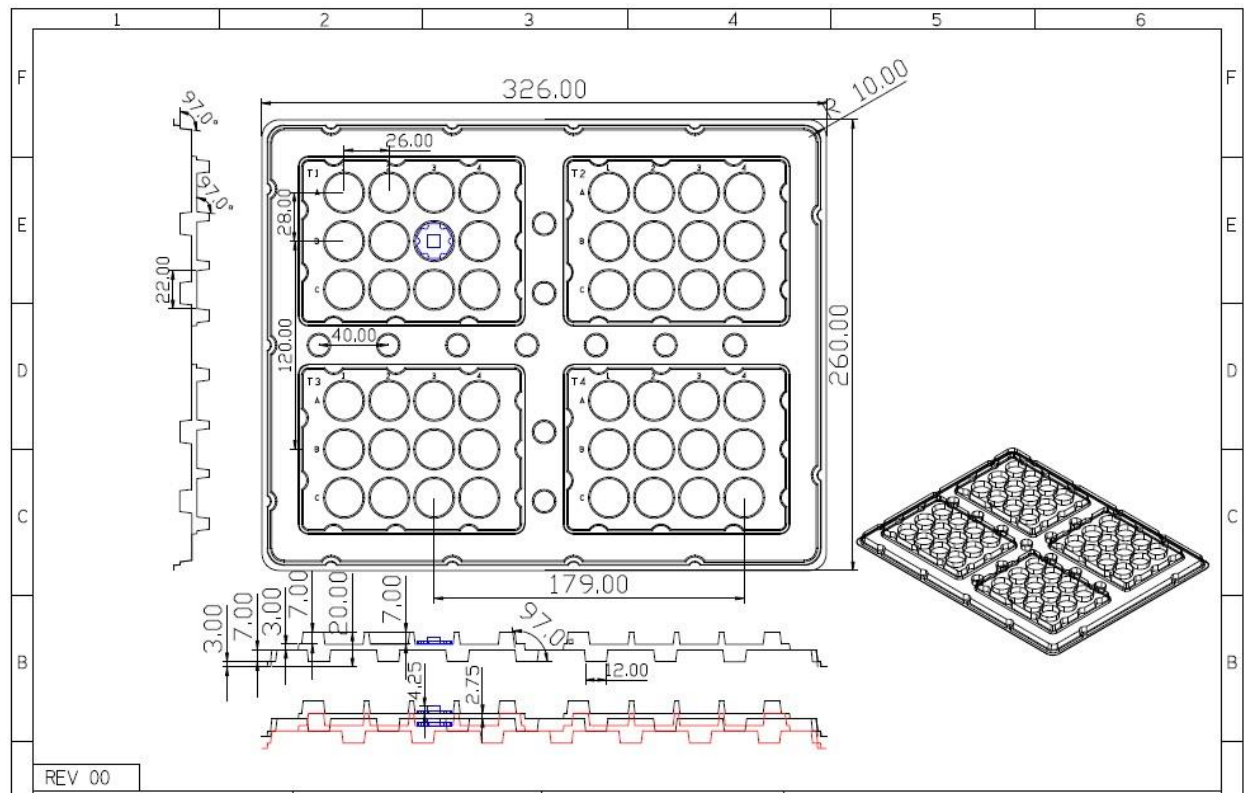
Pocket Carrier Tape Diagram



Reel and Box Label



Packaging Tray for MCPCB Mounted SMD Standard packaging Increment (SPI): 48 parts per tray



Waffle Pak Packaging for SMD Components Samples & Quantities 1-100 pieces



About Kyocera SLD Laser

KYOCERA SLD Laser, Inc. (KSLD) is a wholly owned subsidiary and group company of KYOCERA Corporation, commercializing a new generation of gallium nitride based laser light sources for automotive, mobility, specialty lighting, and consumer applications. The company is ISO 9001 certified and automotive compliant to IATF 16949, and operates facilities in Santa Barbara, CA and in Fremont, CA. KSLD's high luminance LaserLight™ sources are UL and IEC safety certified and are utilized in a myriad of applications including automotive & mobility, specialty & portable lighting, entertainment & outdoor, projection & AR/VR displays, biomedical instrumentation & therapeutics, and industrial imaging & material processing. The company was recently ranked top 20 in Fortune magazine's "2021 Best Workplaces in Manufacturing & Production™," having promoted an employee-centric corporate culture since its founding. To learn more about KSLD, visit www.kyocera-sldlaser.com or contact the company at info@kyocera-sldlaser.com or 1-866-753-5273.

Document Revision History

Document Version	Document Date	Name	
A	2/8/2023	R.Hinahon	Initial Release Datasheet
B	3/30/2023	R.Hinahon	Updated images/logo. Template
C	4/14/2023	R.Hinahon	UL Logo, Front Page

Mouser Electronics

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